

INFORMATION DISCLOSURE CITATION
(Use several sheets if necessary)

ATTY DOCKET NO. EN9-99-073USA SERIAL NO. 10/719495

David J. Alcoe et al.

FILING

11-21-03

GROUP

2813

U.S. PATENT DOCUMENTS

EXAMINER INITIAL	DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE
DA	5,906,042	5/1999	Lan et al.			
	5,900,675	5/1999	Appelt et al.			
	5,894,173	4/1999	Jacobs et al.			
	5,876,842	3/1999	Duffy et al.			
	5,798,563	8/1998	Feilchenfeld et al.			
	5,792,705	8/1998	Wang et al.			
	5,574,630	11/1996	Kresge et al.			
	5,615,087	3/1997	Wieloch			
DA	5,121,190	6/1992	Hsiao et al.			
DA	5,072,075	12/1991	Lee et al.			

FOREIGN PATENT DOCUMENTS

	DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION	
						YES	NO

OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)

EXAMINER

DATE CONSIDERED

6-25-04

EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

INFORMATION DISCLOSURE CITATION (Use several sheets if necessary)				Docket Number (Optional) EN9-99-073USA	Application Number 10/719,495		
				Applicant(s) Alcolea et al	Filing Date 11-21-03		
				Group Art Unit #1A	Group Art Unit #1A		
U.S. PATENT DOCUMENTS							
EXAMINER INITIAL	REF	DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE
	AA						
	AB						
	AC						
	AD						
	AE						
	AF						
	AG						
	AH						
	AI						
	AJ						
	AK						
FOREIGN PATENT DOCUMENTS							
REF	DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	Translation	
AL						YES	NO
AM							
AN							
AO							
AP							
OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)							
DIA	AI	"High Performance Carrier Technology: Materials And Fabrication", by Light et al, 1993 International Electronics Packaging Conference, San Diego, California, Volume One.					
DIA	AS	"High Performance Carrier Technology", by Heck et al, 1993 International Electronics Packaging Conference, San Diego, California, Volume One.					
EXAMINER				DATE CONSIDERED 6-25-04			
EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP Section 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.							

INFORMATION DISCLOSURE CITATION
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Docket Number (Optional)		Application Number
EN9-99-073052		107719495
Applicant(s)		
Alice et al		
Filing Date		Group Art Unit
11-21-03		2813

U.S. PATENT DOCUMENTS

EXAMINER INITIAL	REF	DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE
AA							
AB							
AC							
AD							
AE							
AF							
AG							
AH							
AI							
AJ							
AK							

FOREIGN PATENT DOCUMENTS

EXAMINER INITIAL	REF	DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	Translation	
							YES	NO
AL								
AM								
AN								
AO								
AP								

OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)

DA	AR	"Process Considerations in the Fabrication of Teflon Printed Circuit Boards", by Light et al, 1994 Proceedings, 44 Electronic Components & Technology Conference, 5/94.

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